Hybrid 7p44 Traveler

January 14, 2000

1 Connectivity

Repairs on shorts:

Fixes for opens: PRD1 open on chip 1; jumped from chip 2. Bus 4B open to chip 3; fixed.

2 Chips

The following chips were assembled on this hybrid (in the order that the chips get read out):
Hybrid 7P44 has die: 011-010 123-016 123-017 123-018 123-019 123-023 123-024

3 Data Analysis Summary

The following summarizes the findings of the Burn-in data analysis program. The first chip in the readout name is numbered 0.

```
% Hybrid 7p44 classification info. Created 11:49:39 10/12/99

Hybrid 7p44 quality: fair
Chip classification: fair good fair good good good good
Bad channels (chip-channel): 0-48 0-121 2-1
Bad cells: none
Random bad capacitors: none
Channels at pedestal needed for DCMS: 33.6 36.5 37.6 40.6 34.6 36.6 36.6
```

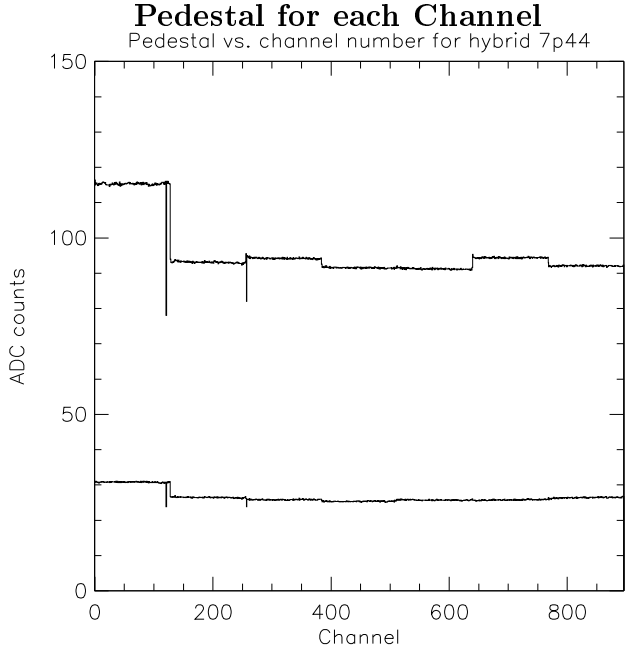
4 Comments

Redundant FE DVDD and DGND wirebonds.
HV test.

5 Pedestal

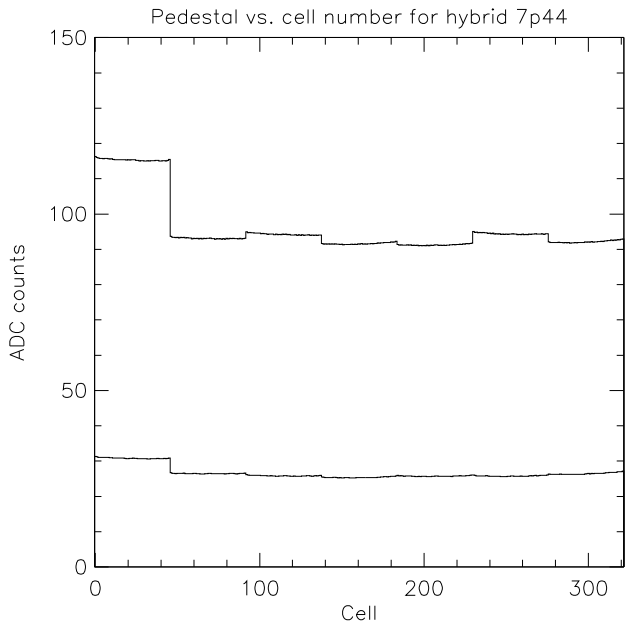
The following plot shows the pedestals vs. channel number with and without charge injection:

Pedestal for each Channel



The following plot shows the average pedestal vs. pipeline cell ID with and without charge injection. The x-axis is cell ID offset by 46 for each chip. Thus cell ID 5 for chip 1 is at x=5, chip 2 at x=51, chip 3 at x=97, etc.

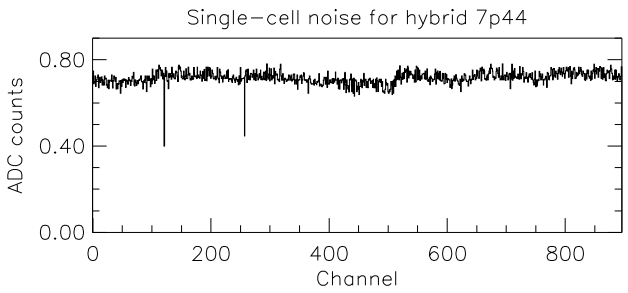
Pedestal vs. Pipeline Cell ID

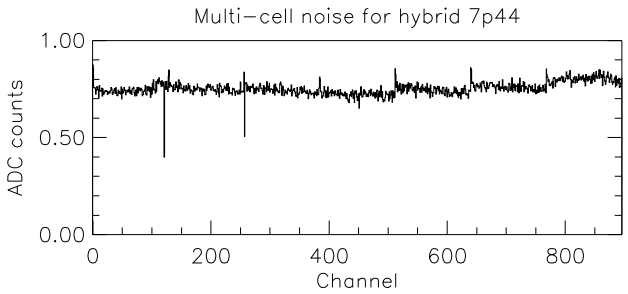


6 Noise

The following plots show the single-cell and multi-cell RMS noise:

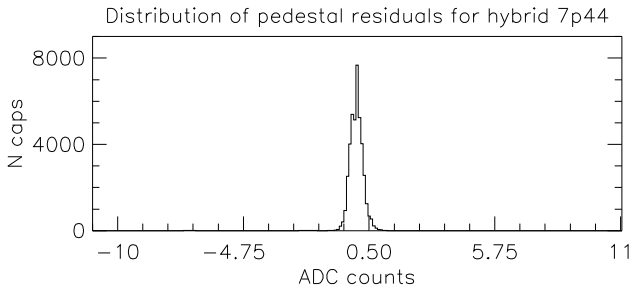
RMS Noise

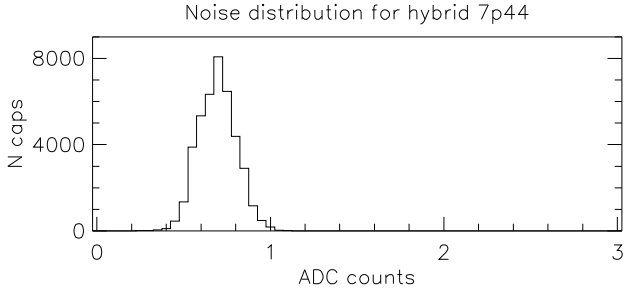




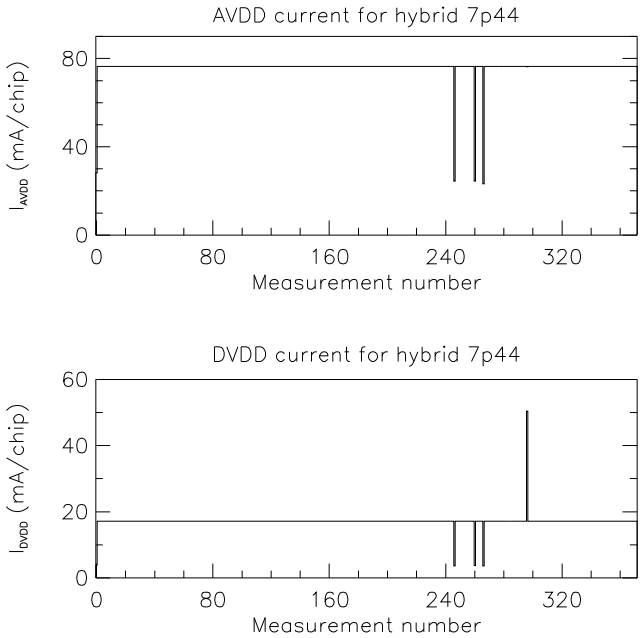
The following are histograms of the pedestal of each pipeline capacitor relative to the chip average (top); and the RMS noise of each capacitor (bottom):

Distribution of Pedestals and Noise





7 Currents

The following plots show the supply currents per chip as a function of measurment number. Currents are measured approximately every 10 minutes:

Supply Currents During Burn-in